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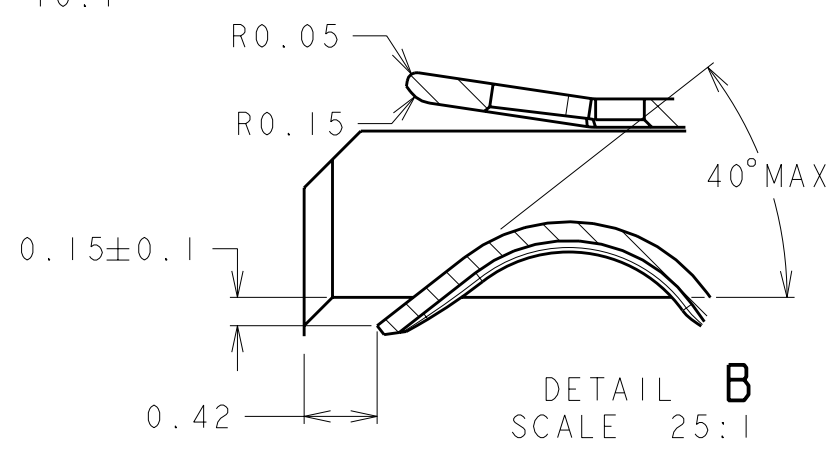
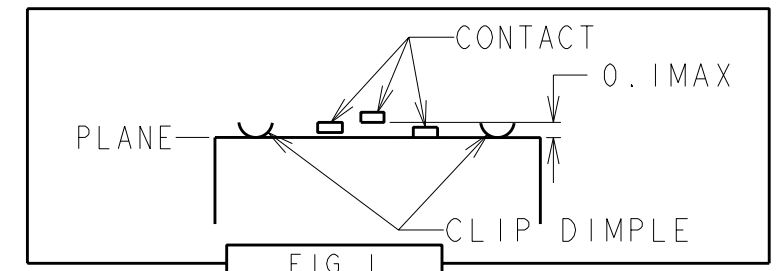
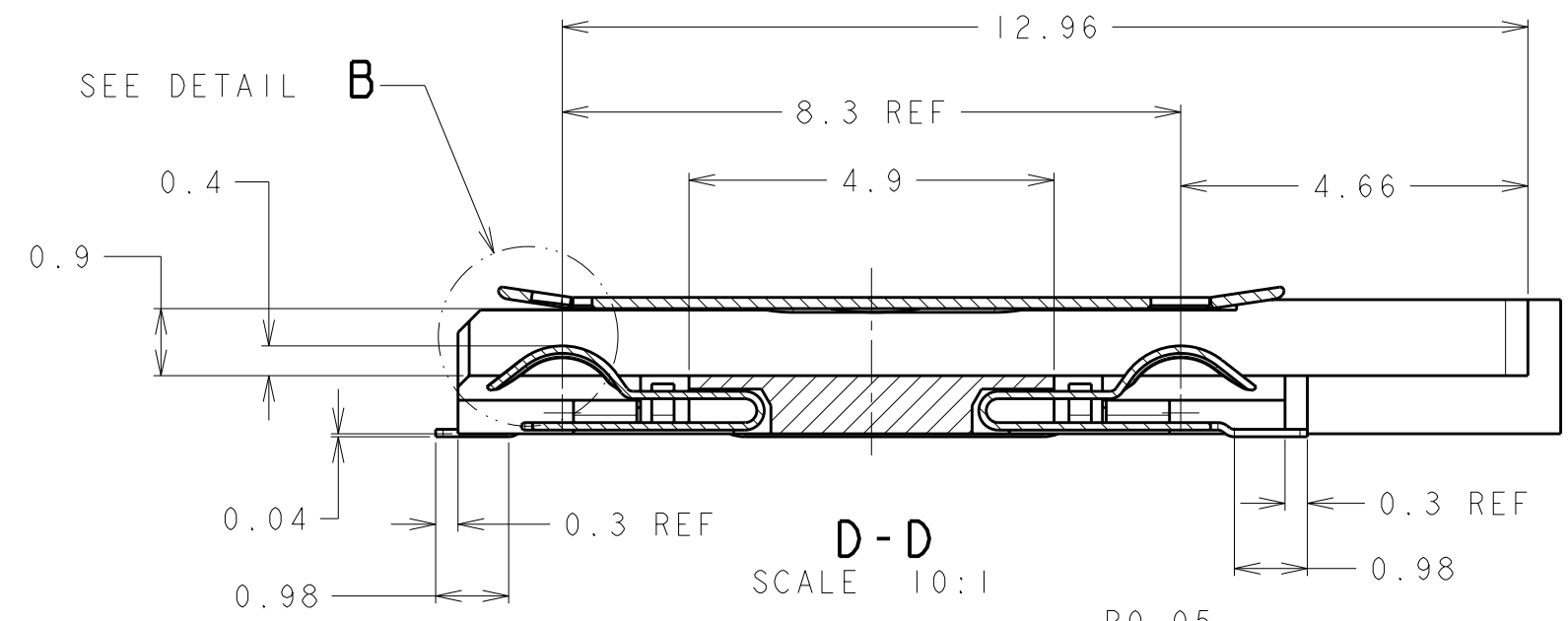
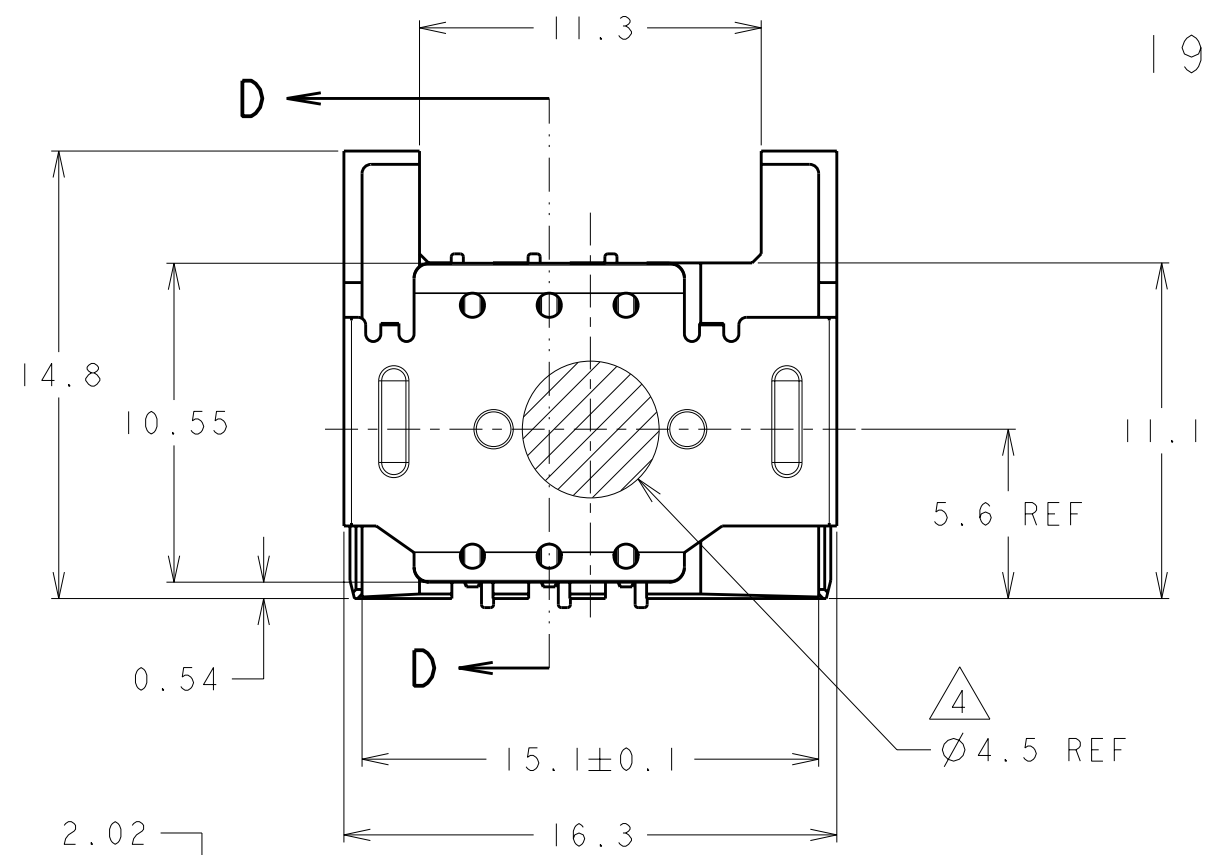
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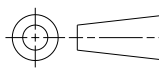
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LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
ES	00		A	INITIAL RELEASE	04MAY2011	S.W	S.Y
			B	REVISED	19JAN2012	S.W	S.Y

1932768-1: AS SHOWN



1. CONTACT: COPPER ALLOY
ALL OVER Ni: 1.27um MIN.
CONTACT AREA PdNi: 1.0um MIN. Au: 0.2um MIN.
SOLDERING AREA Au: 0.05um MIN.
- CLIP: SUS
ALL OVER Ni: 1.3um MIN.
Tin: 1um MIN(ZONE 1).
- HOUSING: THERMOPLASTIC
2. RECOMMENDED SOLDERING THICKNESS: 100um MIN.
RECOMMENDED SOLDERING AREA:
100% OF REFERENCE LAYOUT PATTERN
3. COPLANARITY: 0.1MAX. (SEE FIG.1)
REFERENCE PICK & PLACE AREA.

THIS DRAWING IS A CONTROLLED DOCUMENT FOR TYCO ELECTRONICS CORPORATION IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN	3DEC2010	 TE Connectivity		
		CHK	3DEC2010			
		APVD	3DEC2010			
		PRODUCT SPEC				
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED: ±0.15		NAME SUPER LOW PROFILE SIM H=1.95 WITH FLANGE		
		0 PLC	±	SIZE		
		1 PLC	±	CAGE CODE		
		2 PLC	±	DRAWING NO		
		3 PLC	±	RESTRICTED TO		
MATERIAL		FINISH	±5°	A300779C-1932768		
		WEIGHT		SCALE 4:1		
		CUSTOMER DRAWING		SHEET 1 OF 2		
				REV B		

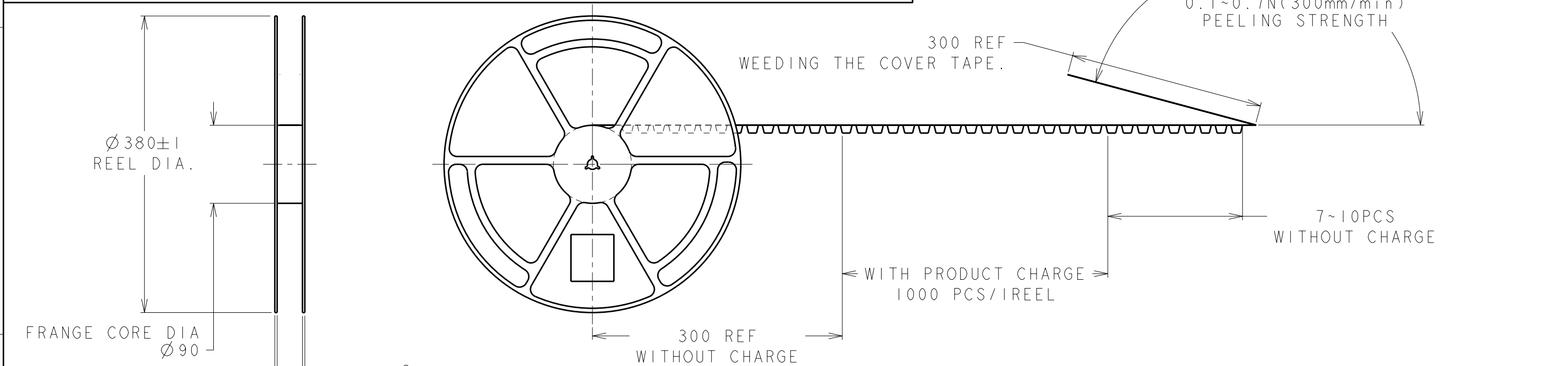
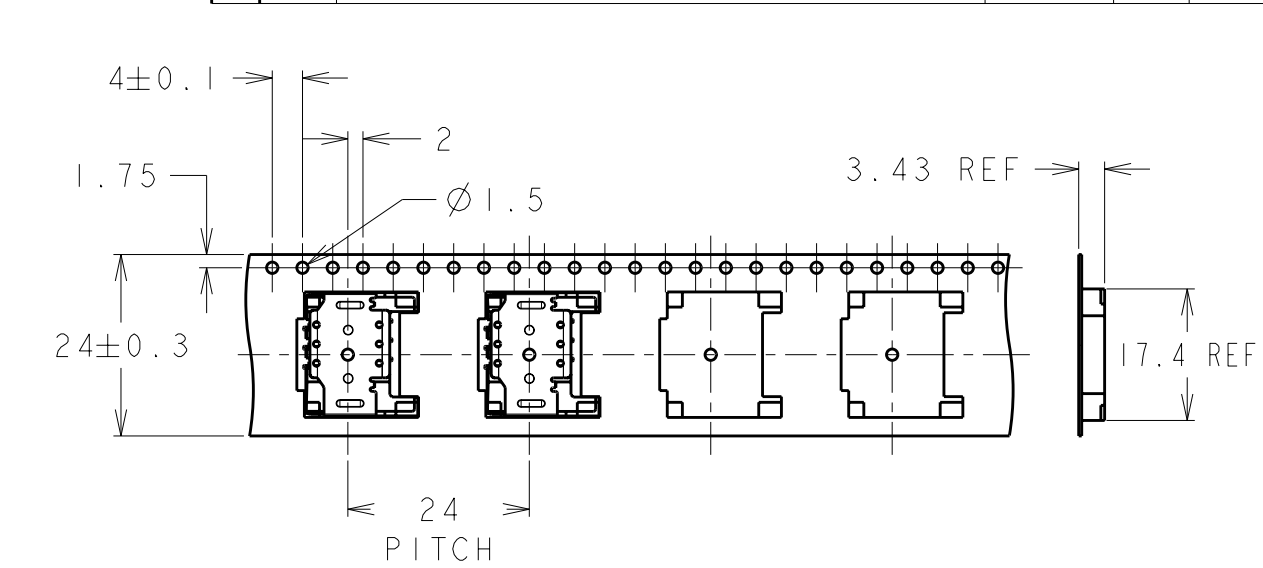
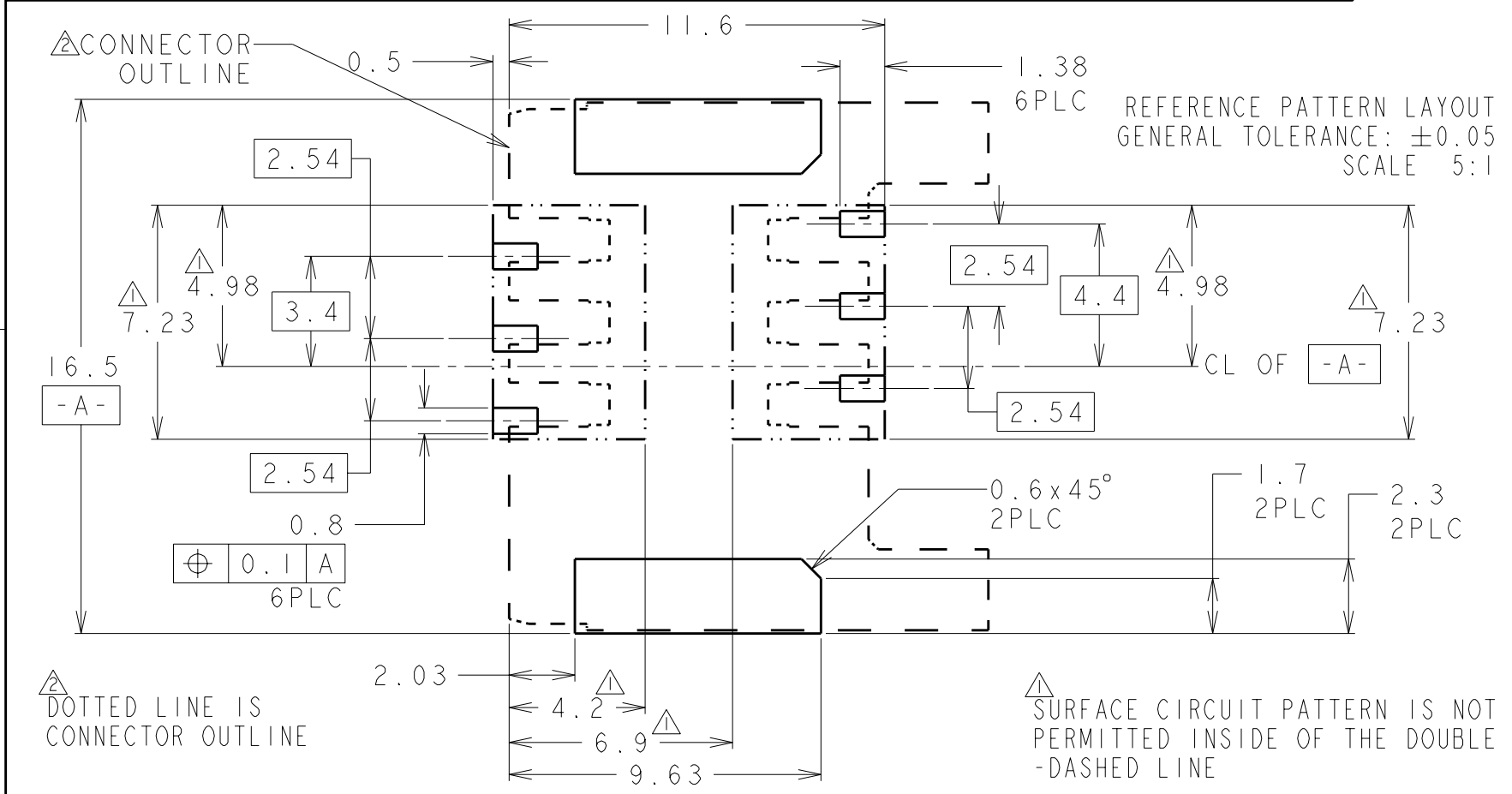
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LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
ES	00		-	SEE SHEET 1	-	-	-



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		CHK		
		APVD	NAME	
		PRODUCT SPEC	SUPER LOW PROFILE SIM H=1.95 WITH FLANGE	
		APPLICATION SPEC		
		WEIGHT	SIZE	CAGE CODE
			A300779	C-1932768
		CUSTOMER DRAWING	SCALE	4:1
			SHEET	2 OF 2
			REV	B